

TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

# SSM6P35FU

- High-Speed Switching Applications
- Analog Switch Applications

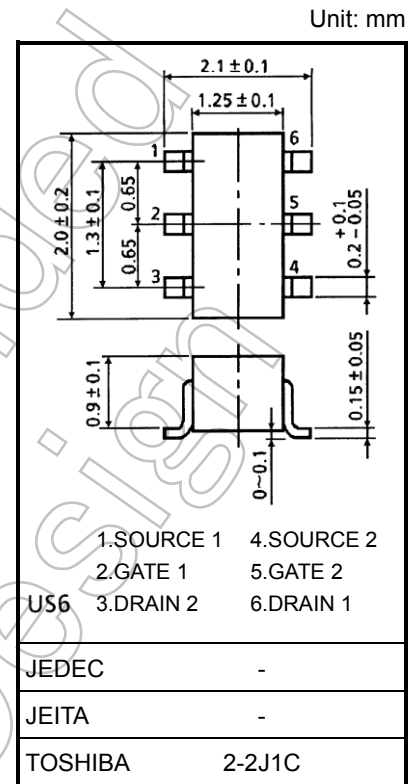
- 1.2-V drive
- Low ON-resistance :  $R_{on} = 44 \Omega$  (max) (@ $V_{GS} = -1.2 V$ )  
                           :  $R_{on} = 22 \Omega$  (max) (@ $V_{GS} = -1.5 V$ )  
                           :  $R_{on} = 11 \Omega$  (max) (@ $V_{GS} = -2.5 V$ )  
                           :  $R_{on} = 8 \Omega$  (max) (@ $V_{GS} = -4.0 V$ )

**Absolute Maximum Ratings ( $T_a = 25^\circ C$ ) (Common to the Q1, Q2)**

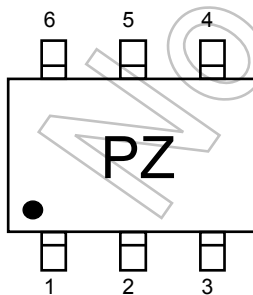
Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	-20	V
Gate-source voltage		$V_{GSS}$	$\pm 10$	V
Drain current	DC	$I_D$	-100	mA
	Pulse	$I_{DP}$	-200	
Drain power dissipation		$P_D$ (Note 1)	200	mW
Channel temperature		$T_{ch}$	150	$^\circ C$
Storage temperature		$T_{stg}$	-55 to 150	$^\circ C$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

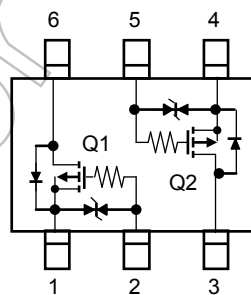
Note 1: Total rating



**Marking**



**Equivalent Circuit (top view)**



Start of commercial production  
2008-03

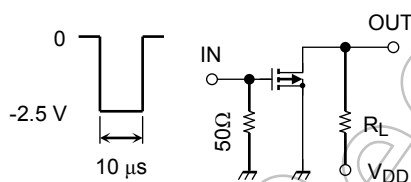
## Electrical Characteristics (Ta = 25°C) (Common to the Q1, Q2)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 10\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = -0.1\text{ mA}, V_{GS} = 0\text{ V}$	-20	—	—	V	
Drain cutoff current	$I_{DSS}$	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}$	—	—	-1	$\mu\text{A}$	
Gate threshold voltage	$V_{th}$	$V_{DS} = -3\text{ V}, I_D = -1\text{ mA}$	-0.4	—	-1.0	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -3\text{ V}, I_D = -50\text{ mA}$ (Note 2)	77	—	—	mS	
Drain-source ON-resistance	$R_{DS(ON)}$	$I_D = -50\text{ mA}, V_{GS} = -4\text{ V}$ (Note 2)	—	4.3	8	$\Omega$	
		$I_D = -50\text{ mA}, V_{GS} = -2.5\text{ V}$ (Note 2)	—	5.6	11		
		$I_D = -5\text{ mA}, V_{GS} = -1.5\text{ V}$ (Note 2)	—	8.2	22		
		$I_D = -2\text{ mA}, V_{GS} = -1.2\text{ V}$ (Note 2)	—	11	44		
Input capacitance	$C_{iss}$	$V_{DS} = -3\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	12.2	—	pF	
Reverse transfer capacitance	$C_{rss}$		—	6.5	—		
Output capacitance	$C_{oss}$		—	10.4	—		
Switching time	Turn-on time	$t_{on}$	$V_{DD} = -3\text{ V}, I_D = -50\text{ mA},$ $V_{GS} = 0\text{ to }-2.5\text{ V}$	—	175	—	ns
	Turn-off time	$t_{off}$		—	251	—	
Drain-source forward voltage	$V_{DSF}$	$I_D = 100\text{ mA}, V_{GS} = 0\text{ V}$ (Note 2)	—	0.83	1.2	V	

Note 2: Pulse test

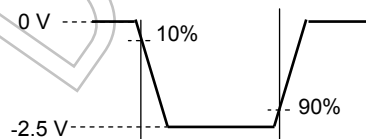
## Switching Time Test Circuit (Common to the Q1, Q2)

### (a) Test Circuit

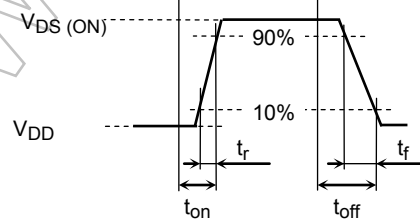


$V_{DD} = -3\text{ V}$   
 Duty  $\leq 1\%$   
 $V_{IN}$ :  $t_r, t_f < 5\text{ ns}$   
 ( $Z_{out} = 50\ \Omega$ )  
 Common Source  
 $T_a = 25^\circ\text{C}$

### (b) $V_{IN}$



### (c) $V_{OUT}$



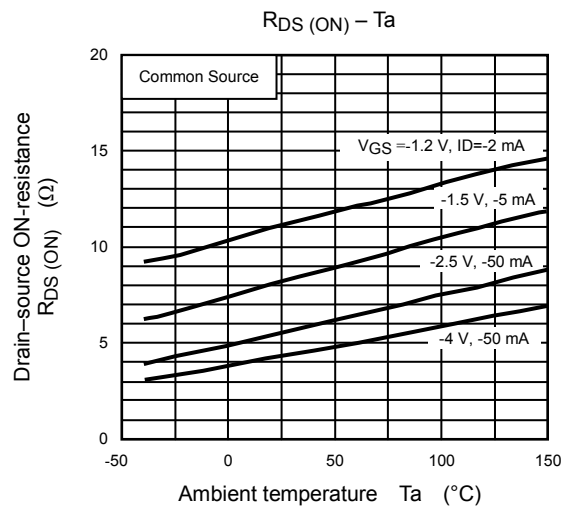
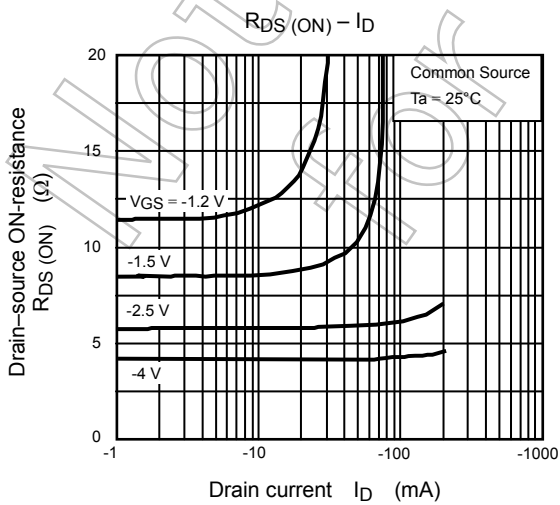
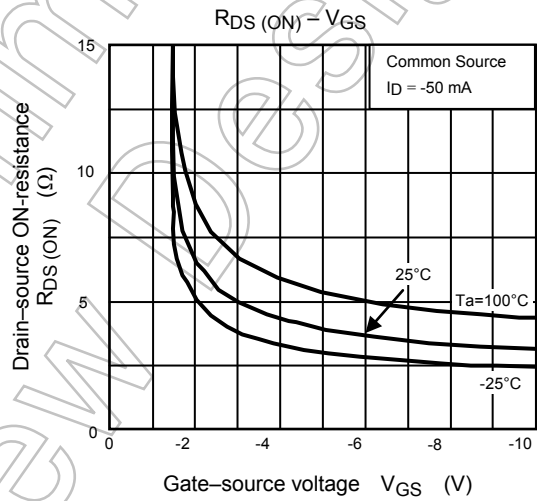
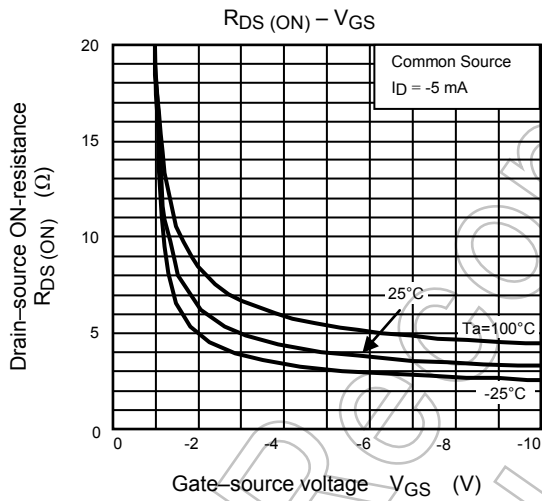
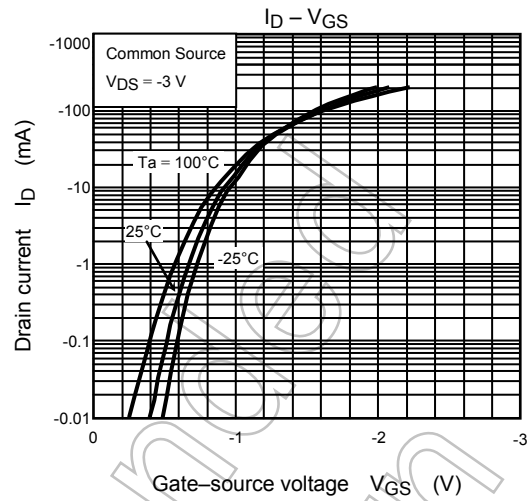
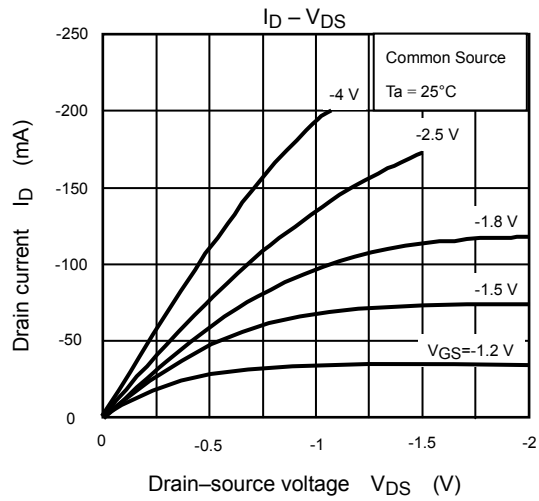
## Notice on Usage

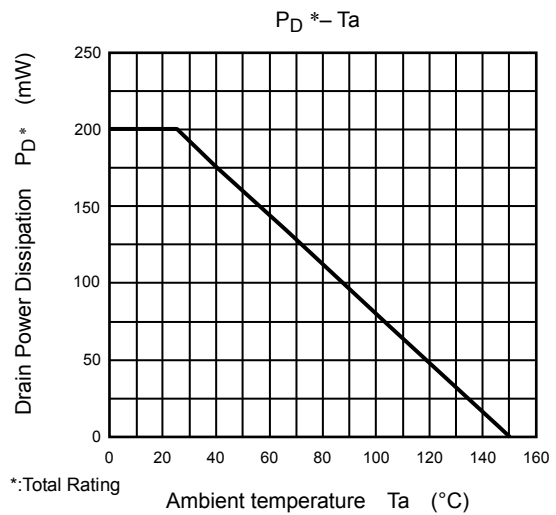
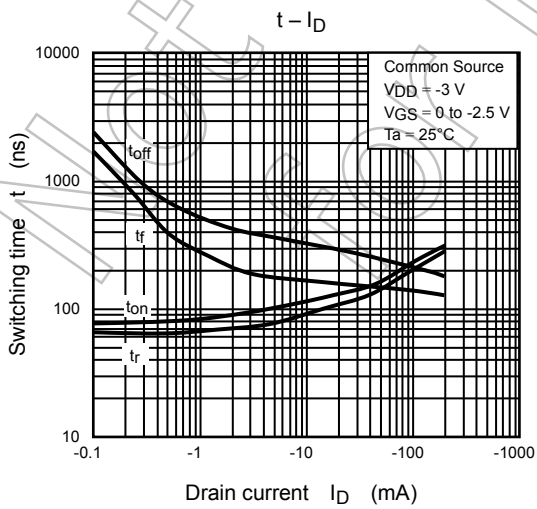
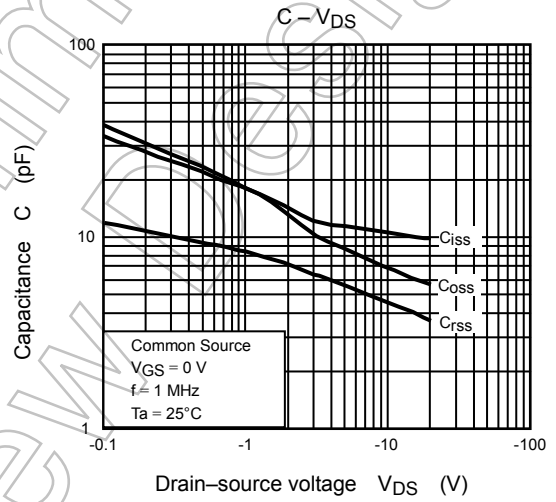
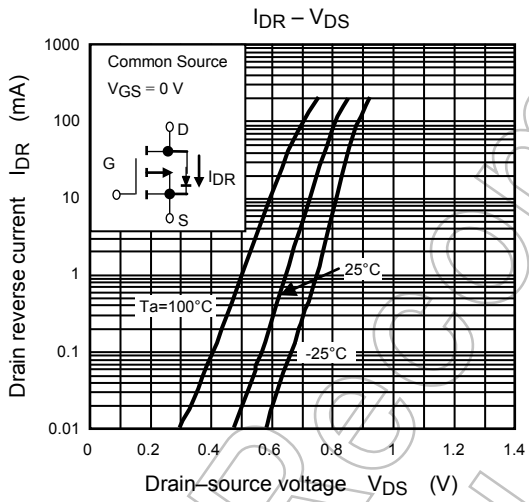
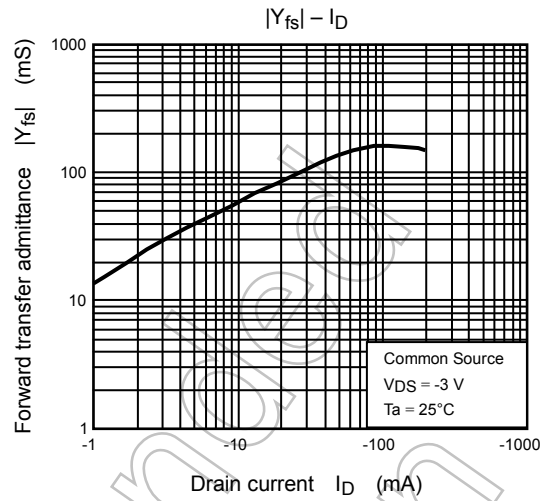
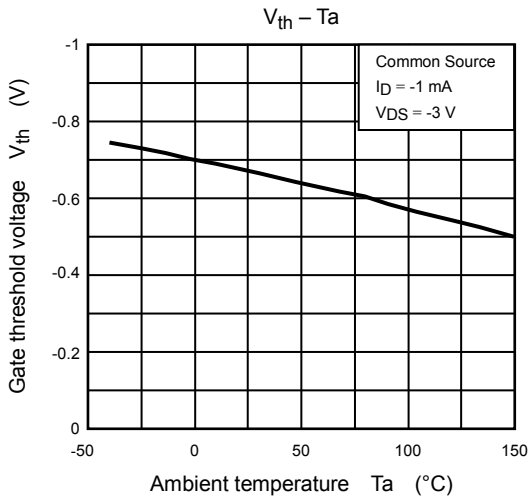
Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current ( $I_D$ ) to be below ( $-1\text{ mA}$  for the SSM6P35FU). Then, for normal switching operation,  $V_{GS(on)}$  must be higher than  $V_{th}$ , and  $V_{GS(off)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ .

Take this into consideration when using the device.

## Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.





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